ROITHNER LASERTECHNIK
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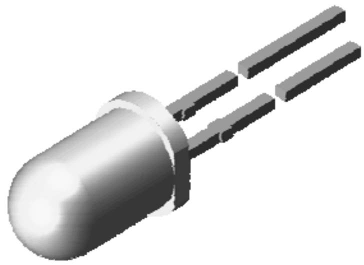
High Speed Infrared Emitting Diode, 905 nm, GaAlAs Double Hetero

Features

- High modulation bandwidth (10 MHz)
- Extra high radiant power and radiant intensity
- Low forward voltage
- Suitable for high pulse current operation
- Standard T-1¾ (∅ 5 mm) package
- Angle of half intensity $\varphi = \pm 22.5°$
- Peak wavelength λ_p = 905 nm
- High reliability
- Good spectral matching to Si photodetectors
- Lead-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



Applications

Infrared high speed remote control and free air data transmission systems with high modulation frequencies or high data transmission rate requirements.

This LED is ideal for the design of transmission systems according to IrDA requirements and for carrier frequency based systems (e.g. ASK / FSK - coded, 450 kHz or 1.3 MHz).

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Reverse Voltage		V_R	5	V
Forward current		I_F	100	mA
Peak Forward Current	$t_p/T = 0.5$, $t_p = 100$ µs	I_{FM}	200	mA
Surge Forward Current	$t_p = 100$ µs	I_{FSM}	1.5	A
Power Dissipation		P_V	160	mW
Junction Temperature		T_j	100	°C
Operating Temperature Range		T_{amb}	- 40 to + 65	°C
Storage Temperature Range		T_{stg}	- 40 to + 100	°C
Soldering Temperature	$t \leq 5$ sec, 2 mm from case	T_{sd}	260	°C
Thermal Resistance Junction/ Ambient		R_{thJA}	270	K/W

Basic Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Forward Voltage	I_F = 100 mA, t_p = 20 ms	V_F		1.85	2.2	V
	I_F = 1 A, t_p = 100 µs	V_F		3.0	3.5	V
Temp. Coefficient of V_F	I_F = 100 mA	TK_{VF}		- 1.7		mV/K
Reverse Current	V_R = 5 V	I_R			10	µA
Junction capacitance	V_R = 0 V, f = 1 MHz, E = 0	C_j		160		pF
Radiant Intensity	I_F = 100 mA, t_p = 20 ms	I_e	25	40	125	mW/sr
	I_F = 1 A, t_p = 100 µs	I_e		400		mW/sr
Radiant Power	I_F = 100 mA, t_p = 20 ms	ϕ_e		35		mW
Temp. Coefficient of ϕ_e	I_F = 100 mA	$TK\phi_e$		- 0.7		%/K
Angle of Half Intensity		φ		± 22.5		deg
Peak Wavelength	I_F = 100 mA	λ_p		905		nm
Spectral Bandwidth	I_F = 100 mA	$\Delta\lambda$		40		nm
Temp. Coefficient of λ_p	I_F = 100 mA	$TK\lambda_p$		0.2		nm/K
Rise Time	I_F = 100 mA	t_r		30		ns
Fall Time	I_F = 100 mA	t_f		30		ns
Virtual Source Diameter	method: 63 % encircled energy	∅		2.1		mm

Typical Characteristics (Tamb = 25 °C unless otherwise specified)

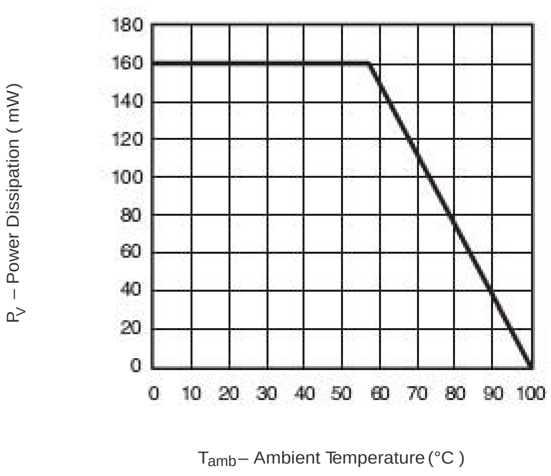


Figure 1. Power Dissipation vs. Ambient Temperature

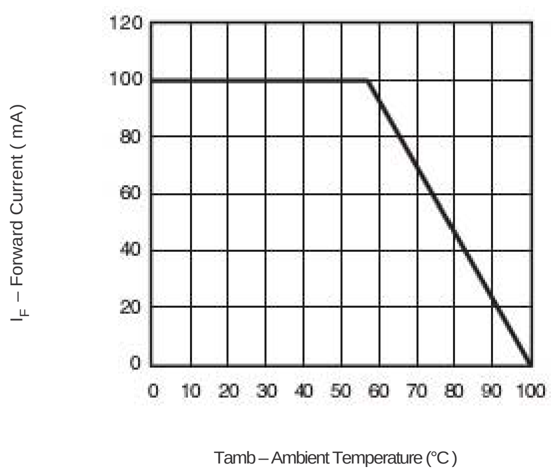


Figure 2. Forward Current vs. Ambient Temperature

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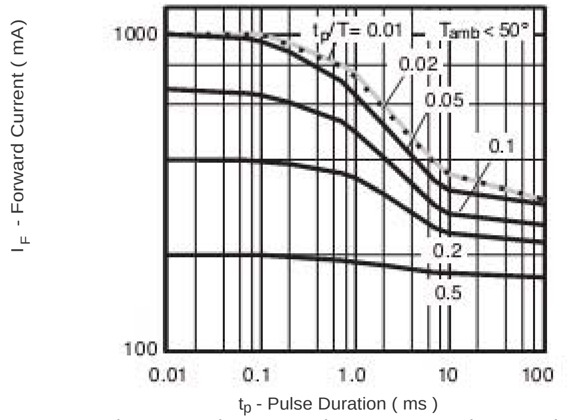

Figure 3. Pulse Forward Current vs. Pulse Duration

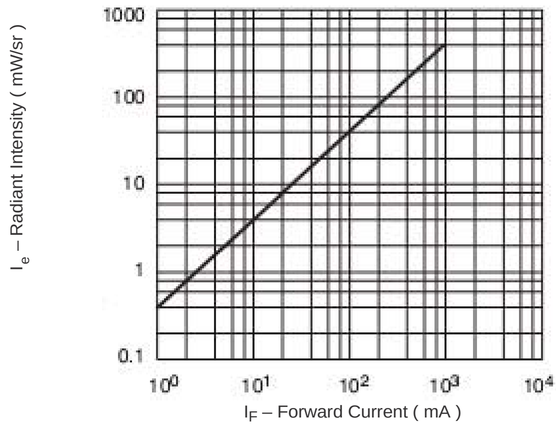

Figure 6. Radiant Intensity vs. Forward Current

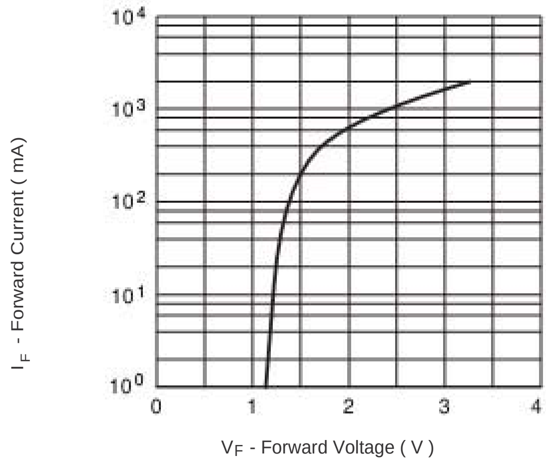

Figure 4. Forward Current vs. Forward Voltage

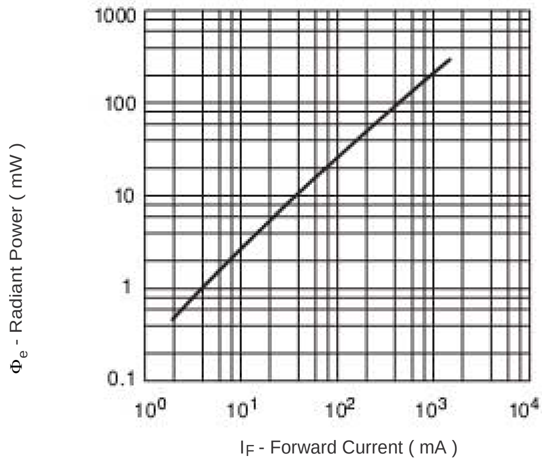

Figure 7. Radiant Power vs. Forward Current

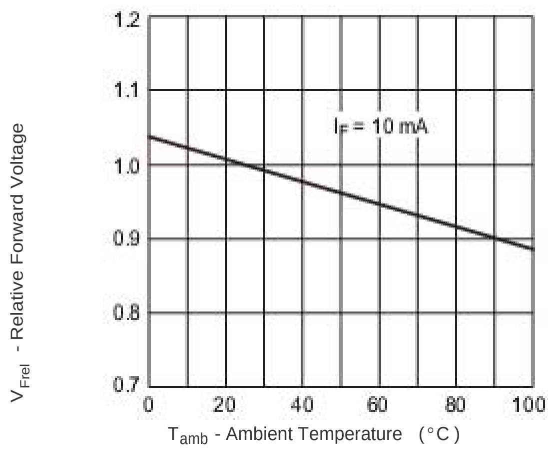

Figure 5. Relative Forward Voltage vs. Ambient Temperature

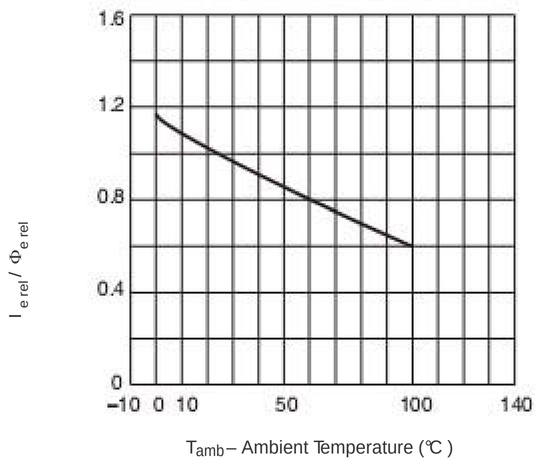

Figure 8. Rel. Radiant Intensity/Power vs. Ambient Temperature

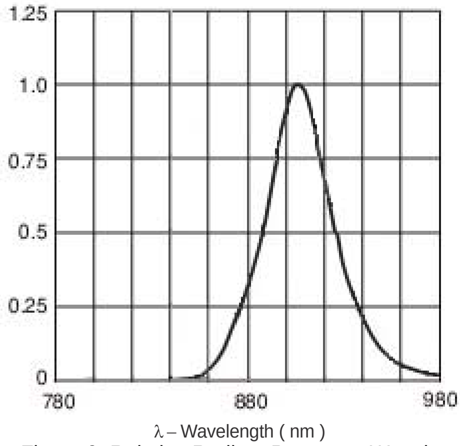

Figure 9. Relative Radiant Power vs. Wavelength

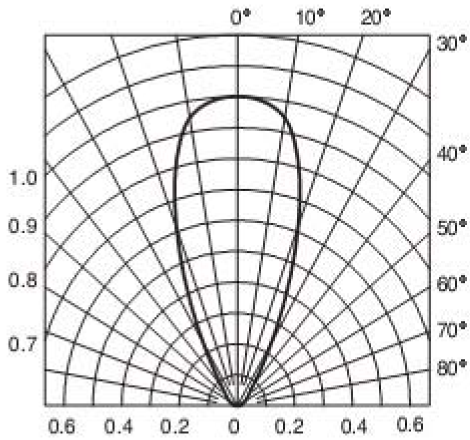

Figure 10. Relative Radiant Intensity vs. Angular Displacement

Package Dimensions in mm